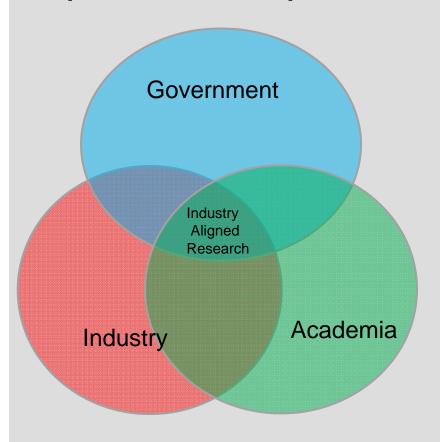


National Centre for Flexible Electronics



Indian Institute of Technology Kanpur

Tripartite Partnership



FlexE Centre - A platform for a meaningful interaction between industry and academia.

An interdisciplinary team that advances the frontiers of research in large area flexible electronics.

Synergistic interaction among industries engaged in product development, materials and equipment manufacturing.

The *centre* will identify national and international collaborators to accelerate project execution and sharpen project objectives by identifying partners with complementary strengths.

FlexE Centre and the partnering institution will define their collaborations in a projects proposal with well-defined deliverables and timelines for completing them.

National Centre for Flexible Electronics



FlexE Centre: Bridge between Academic and Industrial Ecosystem **Industrial Ecosystem** FlexE Centre **Academic Ecosystem** Materials: innovation & Infrastructure scale-up FlexE Team **International** Research **Collaborators Equipment design** R&D **Academic Partners** (faculty, Knowledge students.....) Proof of **Prototype** generation concept **Product industry** Education & training Research support **National Centre for Flexible Electronics** Kanpur

Vision and Objectives

Vision

Conduct research and development in large area flexible electronics that serves as a foundation for development of domestic industry in this field.

Objectives

R&D: Conduct basic studies and scientific investigations relevant to field of large area flexible electronics.

Manufacturing: Conduct research and development in large area flexible electronics by developing partnership with industry and with a view that potentially leads to manufacturing.

Ecosystems: Facilitate formation of industrial ecosystem by addressing various aspects, products, materials and machines and academic ecosystem by engaging with reputed centers internationally and individuals nationally.

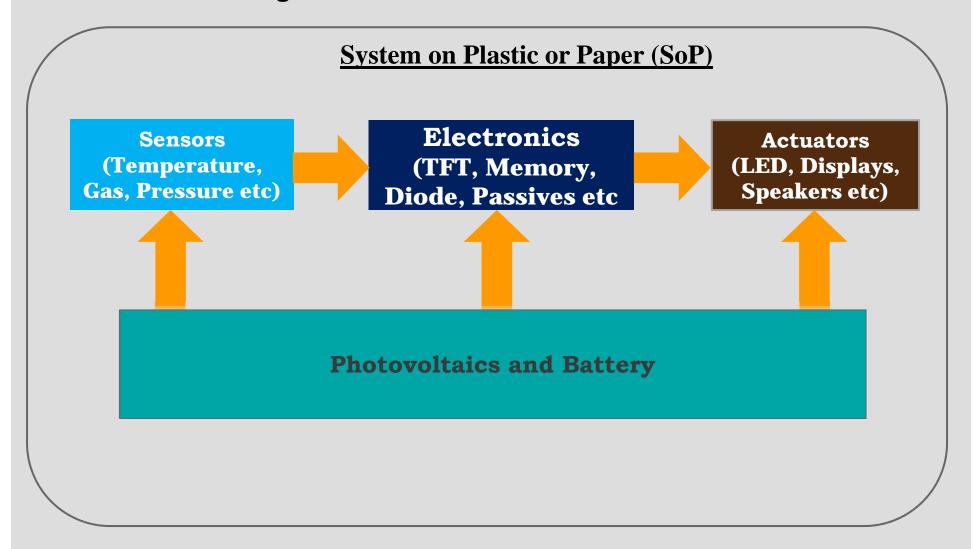
Entrepreneurship: Incubate small scale industry related to flexible electronics

International Partnerships: Build strategic partnerships that hasten the development cycle.

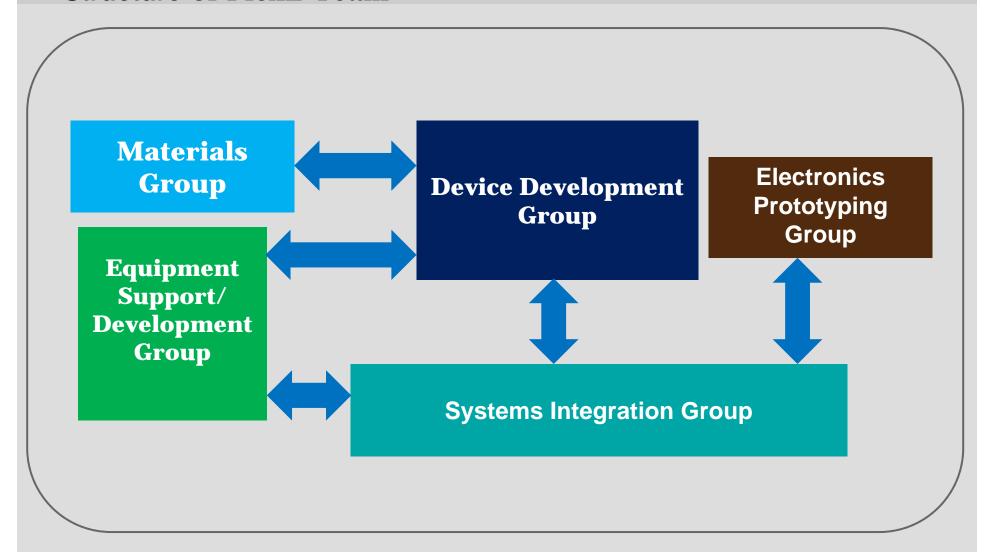
Human Resources: Undertake human resource development in relevant area.



The Scientific Programme



Structure of FlexE Team



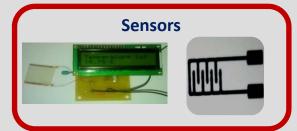


Technologies Available

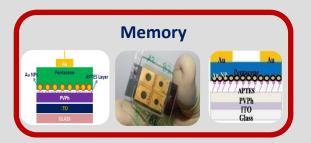










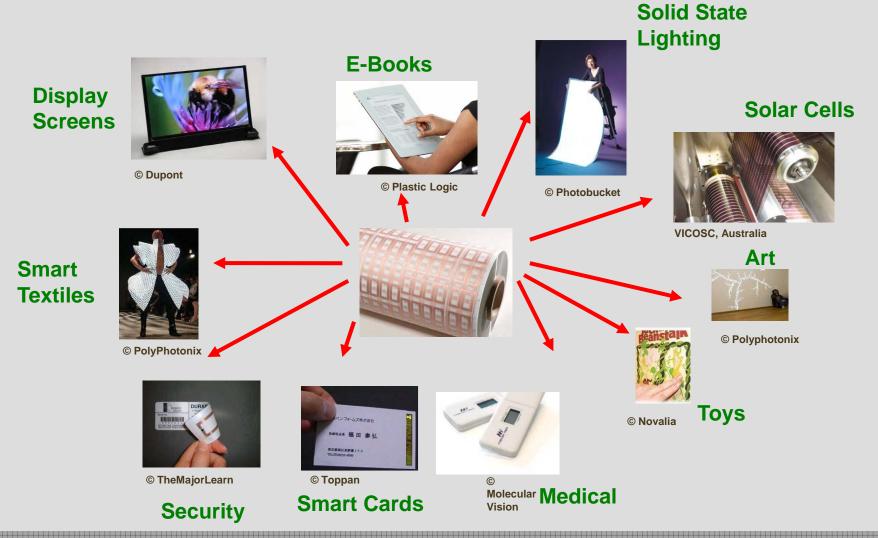


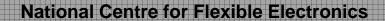






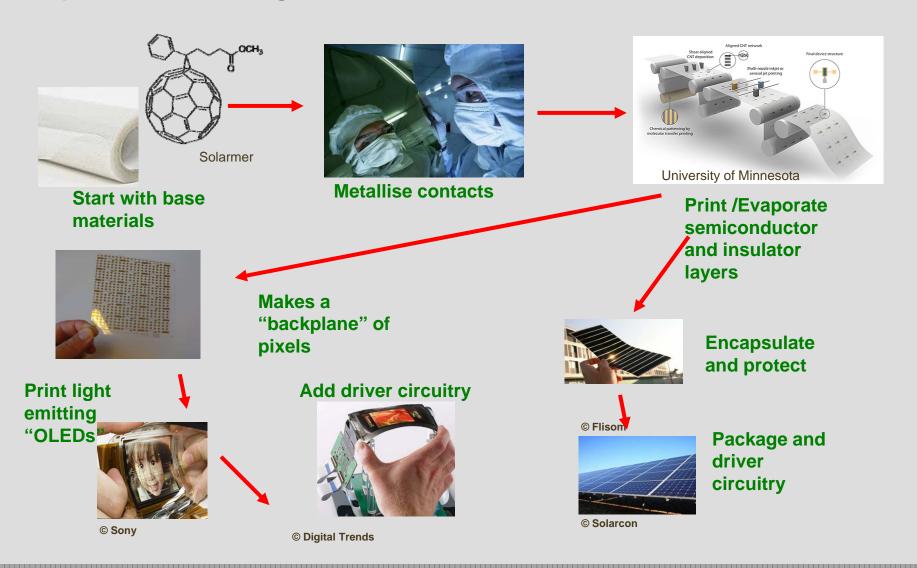
Potential Applications







Simple Manufacturing Process





Infrastructure and Facilities

Current Facilities

- Over 500 m² Cleanroom –
- With facility for wet processing, lithography and bio-material processing.
- Processing Equipment Complete set of processing equipment including evaporators, sputtering, PECVD, RIE and DRIE for inorganic material processing
- **OLED/OPV Facility** Integrated facility for fabrication of OLEDs for display and lighting and OPV modules by evaporation and spin coating.
- Chemistry Lab A well equipped chemistry lab for synthesis of molecules, nanoparticles and inks for printing.
- Characterization Wide range of in-house electrical, optical and structural characterization facility for thin films and devices.







Upcoming Facilities

A new clean room with State-of-the-art processing facilities

In addition to the above facilities a new building is being constructed to house following facilities:

- A 700 m² clean room and 500 m² non-clean lab space.
- Roll to Roll printing facilities (gravure, flexo, screen, slot-die etc.)
- Dryers (Flash, IR, thermal etc.) for printed films.
- Roll to Roll vacuum deposition facility.
- Process/material/device simulation laboratory.
- Monitoring and characterization facility for roll to roll printed thin films and devices.
- Device integration and prototyping.



New Building





Summary

- ☐ A World Class centre working at the frontiers of research in large area flexible electronics
- ☐ Industry aligned research with collaborative partnership with academia and industry
- ☐ Transform promising ideas into proof-of-concept devices
- ☐ Fabricate prototypes in collaboration with industry
- ☐ Participate in knowledge generation
- ☐ Spark invention by accelerating the process of trial-and error



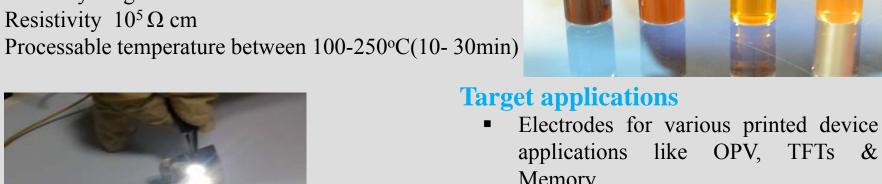
Technology Commercialization



Conductive Inks

Current specifications

- Au & Ag based Inkjet printable conductive inks
- Viscosity range 3-10cP
- Resistivity $10^5 \Omega$ cm



Capabilities

- Basic chemistry lab facility for synthesis
- Chemical characterisation tools
- Ink formulation & characterisation tools
- Printable ink tester for inkjet, gravure, flexography & screen printers



Any printed electronics circuit

elements

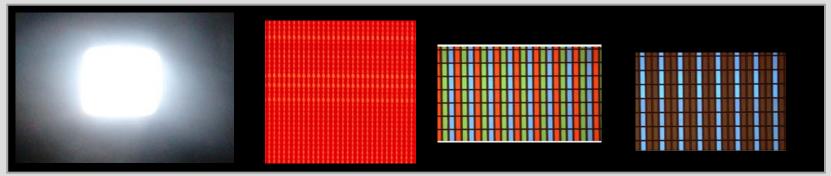


Patent portfolio: 1 patent applied

National Centre for Flexible Electronics



Solid State Lighting: OLED



- Large range of colours and design possible
- Flexible substrates

Current Capabilities

 Full fabrication facility for light panels of size 10 cm x 10 cm on rigid substrate

Future Expansion

 Fabrication facility for roll-to-roll processing on flexible substrate

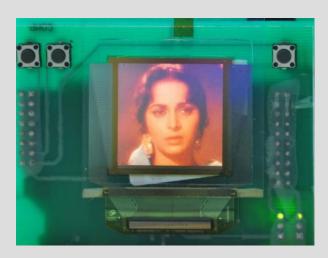
Patent portfolio: 4 patents applied

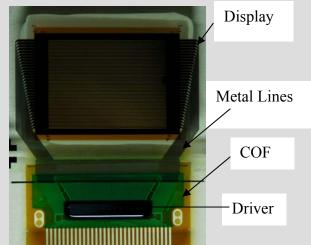
Target applications

- Strategic application:-light weight lighting source
- Urban application
 - Lamps and decorative panels
 - Furniture and building integrated lighting
 - Mood lighting

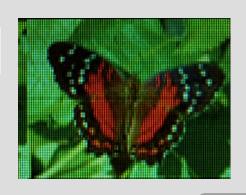


OLED DISPLAYS



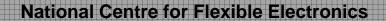






Display module, full color 96 (3) x 64, 1", passive matrix, consisting of the OLED display, COF and driver.

Patent portfolio: 4 patents applied





Sensors

Technology focus

Sensor device design and fabrication

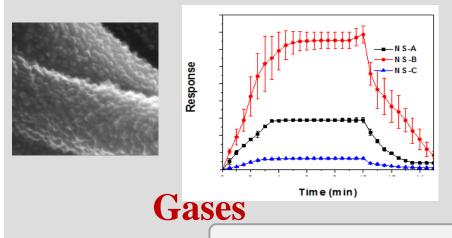
Sensor arrays, multianalyte detection

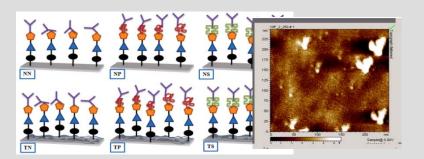
Application areas

Healthcare, environmental, biomedical and food packaging, medical, process engineering, safety



Temperature





Disease diagnostics

Patent portfolio: 1 patent granted, 6 applications pending



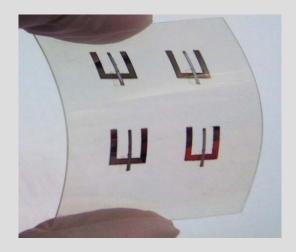
Low cost, printable electronics based tags

- Tags with printed electronic circuits for brand protection
- Smart tags incorporating memory and sensors

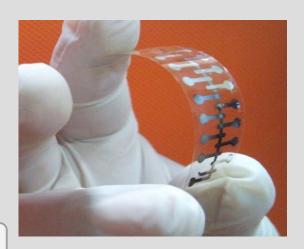


- Brand protection
- Tracking for goods
- Excise controls

Patent portfolio: 3 patents applied



Passive Tag



16-bit memory label



Organic Photovoltaic Sub-modules

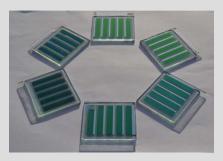
Current capability

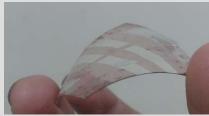
On Glass Substrate

• Sub-modules of size 10 cm x 10 cm

On Steel Substrate

• Small area device 3 mm x 3 mm







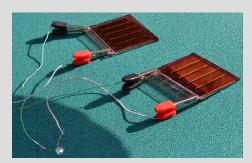
Patent portfolio: 7 patents applied

Working towards

- Sub-modules on steel substrate
- Sub-modules on paper & PET substrate
- High throughput printing process

Target applications

- Light weight power generation source
- Portable solar PV device on flexible substrate







Summary

FlexE Centre, IIT Kanpur is seeking academic and industry partners to further advance the frontiers of research in large area flexible electronics

